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Dimensions	
D	6.3mm +/-0.5mm
L	7.7mm +/-0.3mm
W	0.65mm +/-0.1mm
F	0.3mm MAX
A	6.6mm +/-0.2mm
B	6.6mm +/-0.2mm
C	7.8mm MAX
E	2.6mm +/-0.2mm
G	0.35mm +0.15/-0.2mm
P	1.8mm +/-0.2mm

Packaging Specifications	
Packaging	T&R, 380mm
Packaging Quantity	1000

General Information	
Series	EXV
Dielectric	Aluminum Electrolytic
Style	SMD Can
Description	Surface Mount, Aluminum Electrolytic
Features	Ultra Low Impedance
RoHS	Yes
Lead	V-Chip
AEC-Q200	No

Specifications	
Capacitance	150 uF
Capacitance Tolerance	20%
Voltage DC	6.3 VDC, 8 VDC (Surge)
Temperature Range	-55/+105°C
Rated Temperature	105°C
Life	3000 Hrs
Dissipation Factor	26%
Resistance	0.3 Ohms (100kHz)
Ripple Current	168 mAmps (120Hz), 336 mAmps (120Hz 85C), 240 mAmps (100kHz)
Leakage Current	9.5 uA (2min 20°C)
Impedance Ratio at -25C	2
Impedance Ratio at -40C	3
High Temperature Solder	Yes